Texas Instruments

Bill of Materials

TI DESIGNS TIDA - 00110

Qty	Reference	Part Description	Manufacturer	Manufacturer Part Number	PCB Footprint	DNIe
1	!PCB1	Printed Circuit Board	Any	TIDA-00110		
4	C1, C23, C30, C34	CAP, CERM, 0.047uF, 50V, +/-10%, X7R, 0603	TDK	C1608X7R1H473K	0603	
8	C2, C3, C21, C22, C28, C32, C37, C38	CAP, CERM, 4700pF, 50V, +/-10%, X8R, 0603	TDK	C1608X8R1H472K	0603	
6	C4, C14, C20, C26, C31, C48	CAP, TA, 10 µF, 16 V, +/- 10%, 2 ohm, SMD	AVX	F931C106KBA	3528-21	
1	C5	CAP, CERM, 1000pF, 100V, +/-5%, X7R, 0603	AVX	06031C102JAT2A	0603	
0	C6, C7, C11, C13, C18, C24, C25, C27, C33, C35, C36	CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	AVX	06035C104KAT2A	0603	DNI
7	C8, C15, C17, C19, C29, C50, C52	CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	AVX	06035C104KAT2A	0603	
2	C9, C10	CAP, CERM, 3300pF, 50V, +/-10%, X7R, 0603	Kemet	C0603C332K5RACTU	0603	
1	C12	CAP, CERM, 0.033uF, 50V, +/-10%, X7R, 0603	MuRata	GRM188R71H333KA61D	0603	
1	C16	CAP, CERM, 4.7uF, 50V, +/-10%, X5R, 0805	TDK	C2012X5R1H475K125AB	0805	
2	C39, C55	CAP, CERM, 1000pF, 2KV 10% X7R 1206	Johanson Dielectrics Inc	202R18W102KV4E	1206	
13	C40, C41, C42, C43, C46, C47, C49, C51, C53, C54, C56, C57, C58	CAP CER 1000PF 100V 10% X7R 1206	Yageo	CC1206KRX7R0BB102	1206	
2	C44, C45	CAP, CERM, 0.1uF, 25V, +/-5%, X7R, 0603	AVX	06033C104JAT2A	0603	
13	D1, D2, D3, D4, D12, D15, D19, D20, D21, D23, D27, D28, D30	TVS DIODE 11.1VWM 18.2VC SMD	Littelfuse Inc	P4SMA13CA	SMA	
8	D5, D18, D31, D32, D33, D34, D35, D36	Diode, Schotky, 200V, 1A, PowerDI123	DIODES INCORPORATED	DFLS1200-7	PowerDI123	
0	D6, D7, D9, D11, D16, D17, D22, D24, D25, D26	TVS DIODE,70VVVM,8VC,SOT-323	DIODES INCORPORATED	DESD1P0RFW-7	SOT-323	DNI
3	D8, D10, D13	LED, SMARTLED, GREEN, 570NM,0603	OSRAM OPTO SEMICONDUCTORS Inc	LG L29K-G2J1-24-Z	0603	
1	D14	DIODE ZENER 3.8V 1W PMDS	Rohm Semiconductor	PTZTE253.6B	DO-214AC, SMA	
1	D29	TVS 18 VOLT 600 WATT BI-DIR SMB	Littelfuse Inc	SMBJ18CA	SMB	
0	H1, H2, H3, H4	Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	B&F Fastener Supply	NY PMS 440 0025 PH	Screw	DNI
5	J1, J2, J4, J5, J6	Receptacle, 100mil, 4X1 TH	TE Connectivity	282834-4	10.62x10x6.5 mm	
1	J3	Terminal Block, 8x1, 2.54 mm, TH	Phoenix Contact	1725711	8POS Terminal Block	
1	J7	Terminal Block, 2x1, 2.54mm, TH	TE Connectivity	282834-2	Terminal Block, 2x1, 2.54mm, TH	
1	L1	FERRITE CHIP 1000 OHM 300MA 0603	TDK Corporation	MMZ1608B102C	0603	

Qty	Reference	Part Description	Manufacturer	Manufacturer Part Number	PCB Footprint	DNIe
0	LBL1	Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	Brady	THT-14-423-10	PCB Label 0.650"H x 0.200"W	DNI
2	Q1, Q2	MOSFET, N-CH, 30V, 22A, SON 2X2 MM	TEXAS INSTRUMENTS	CSD17571Q2	DQK	
8	R1, R2, R28, R30, R45, R51, R54, R55	RES, 4.12k ohm, 0.1%, 0.1W, 0603	Susumu Co Ltd	RG1608P-4121-B-T5	0603	
1	R3	RES 2K OHM 1/4W 0.1% 1206	Vishay-Dale	TNPW12062K00BEEA	1206	
2	R4, R10	RES, 4.70k ohm, 0.1%, 0.1W, 0603	Susumu Co Ltd	RG1608P-472-B-T5	0603	
10	R5, R6, R15, R17, R31, R32, R48, R49, R52, R53	RES, 249, 1%, 0.1 W, 0603	Vishay-Dale	CRCW0603249RFKEA	0603	
4	R7, R8, R12, R13	RES, 300 ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW0603300RJNEA	0603	
1	R9	RES, 0 ohm, 5%, 0.125W, 0805	Yageo America	RC0805JR-070RL	0805	
0	R11, R46, R50	RES, 10 k, 5%, 0.1 W, 0603	Vishay-Dale	CRCW060310K0JNEA	0603	DNI
0	R14	RES, 0, 5%, 0.1 W, 0603	Vishay-Dale	CRCW06030000Z0EA	0603	DNI
6	R16, R18, R25, R27, R38, R41	RES, 10 k, 5%, 0.1 W, 0603	Vishay-Dale	CRCW060310K0JNEA	0603	
10	R19, R20, R21, R22, R24, R29, R33, R34, R35, R36	RES, 0, 5%, 0.1 W, 0603	Vishay-Dale	CRCW06030000Z0EA	0603	
8	R23, R37, R39, R40, R42, R43, R44, R47	RES, 100, 1%, 0.1 W, 0603	Vishay-Dale	CRCW0603100RFKEA	0603	
1	R26	RES, 1.2 k, 5%, 0.1 W, 0603	Vishay-Dale	CRCW06031K20JNEAHP	0603	
2	R56, R57	RES, 2.0 k, 5%, 0.1 W, 0603	Yageo America	RC0603JR-072KL	0603	
10	TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8, TP9, TP10	Test Point 40mil pad 20mil drill	STD	STD		
1	U1	Single Output LDO, 100 mA, Fixed 3.3 V Output, 3 to 60 V Input, with Enable and Power Good, 8-pin MSOP (DGN), -40 to 125 degC, Green (RoHS & no Sb/Br)	Texas Instruments	TPS7A1633DGNR	DGN0008C	
1	U2	Low-Voltage 8-Bit I2C and SMBus	Texas Instruments	TCA6408APWR	PW0016A	
1	U3	IC, Dual, 14 Ohms SP4T Analog	TI	TS3A5017D	SO16	
1	U4	IC, 24-Bit A-D Converters for	TI	ADS1248IPW	TSSOP-28	

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